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MICROWAVE CORPORATION v04.0811



HMC513LP5 / 513LP5E

MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 10.43 - 11.46 GHz

Typical Applications

Low noise MMIC VCO w/Half Frequency, Divide-by-4
Outputs for:

- VSAT Radio
- Point to Point/Multipoint Radio
- Test Equipment & Industrial Controls
- Military End-Use

Features

Dual Output: $F_o = 10.43 - 11.46$ GHz
 $F_o/2 = 5.21 - 5.73$ GHz

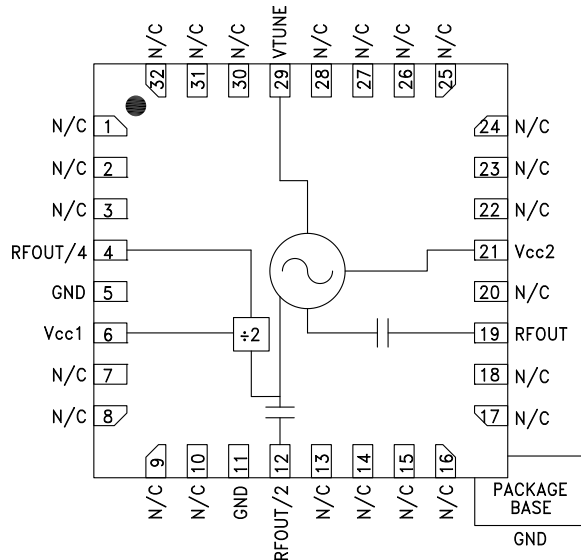
Pout: +7 dBm

Phase Noise: -110 dBc/Hz @100 KHz Typ.

No External Resonator Needed

32 Lead 5x5mm SMT Package: 25mm²

Functional Diagram



General Description

The HMC513LP5 & HMC513LP5E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs. The HMC513LP5 & HMC513LP5E integrate resonators, negative resistance devices, varactor diodes and feature half frequency and divide-by-4 outputs. The VCO's phase noise performance is excellent over temperature, shock, and process due to the oscillator's monolithic structure. Power output is +7 dBm typical from a +3V supply voltage. The prescaler function can be disabled to conserve current if not required. The voltage controlled oscillator is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

Electrical Specifications, $T_A = +25^\circ\text{C}$, V_{cc1} , $V_{cc2} = +3\text{V}$

Parameter	Min.	Typ.	Max.	Units
Frequency Range				
F_o		10.43 - 11.46		GHz
$F_o/2$		5.215 - 5.73		GHz
Power Output				
RFOUT	+5		+10	dBm
RFOUT/2	+5		+11	dBm
RFOUT/4	-10		-4	dBm
SSB Phase Noise @ 100 kHz Offset, $V_{tune} = +5\text{V}$ @ RFOUT		-110		dBc/Hz
Tune Voltage				
V_{tune}	2		13	V
Supply Current				
I_{cc1} & I_{cc2}	240	275	290	mA
Tune Port Leakage Current ($V_{tune} = 13\text{V}$)			10	μA
Output Return Loss		2		dB
Harmonics/Subharmonics				
1/2		32		dBc
3/2		26		dBc
2nd		15		dBc
3rd		28		dBc
Pulling (into a 2.0:1 VSWR)		5		MHz pp
Pushing @ $V_{tune} = 5\text{V}$		25		MHz/V
Frequency Drift Rate		1		MHz/ $^\circ\text{C}$

For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824

Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

Application Support: Phone: 978-250-3343 or apps@hittite.com



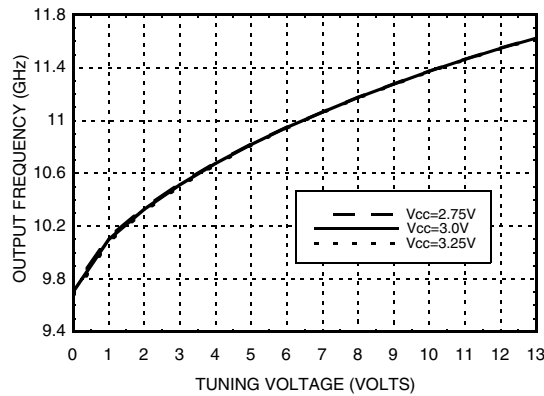
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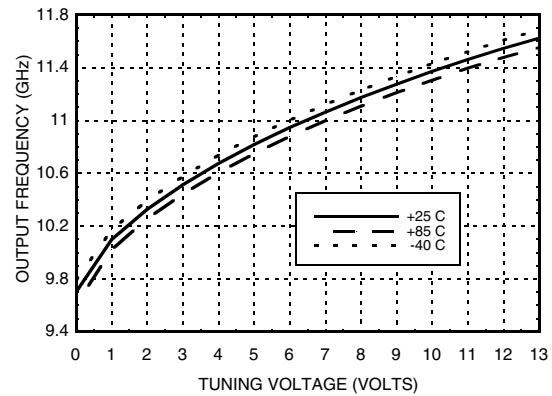
HMC513LP5 / 513LP5E

MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 10.43 - 11.46 GHz

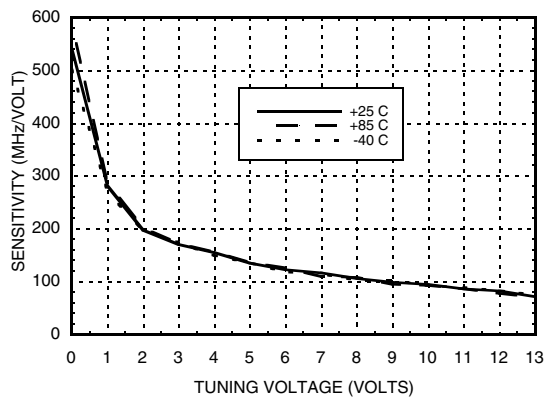
Frequency vs. Tuning Voltage, $T = 25^{\circ}\text{C}$



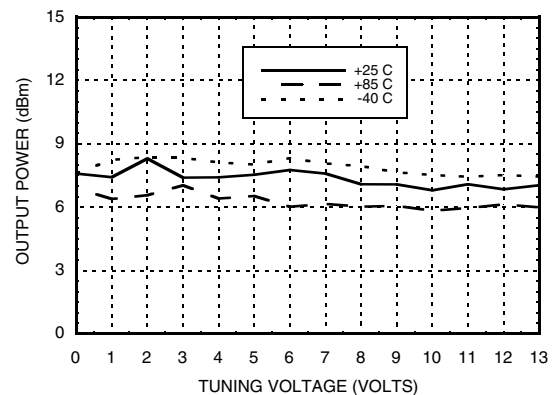
Frequency vs. Tuning Voltage, $V_{cc} = +3V$



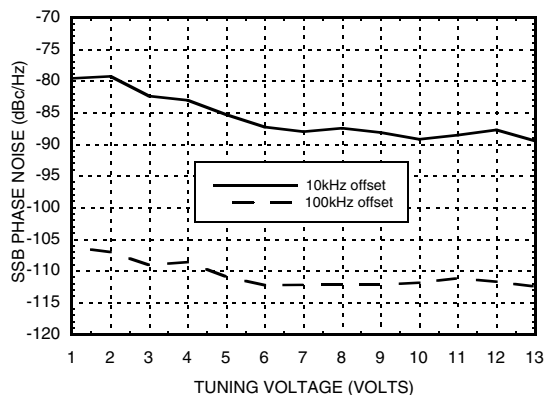
Sensitivity vs. Tuning Voltage, $V_{cc} = +3V$



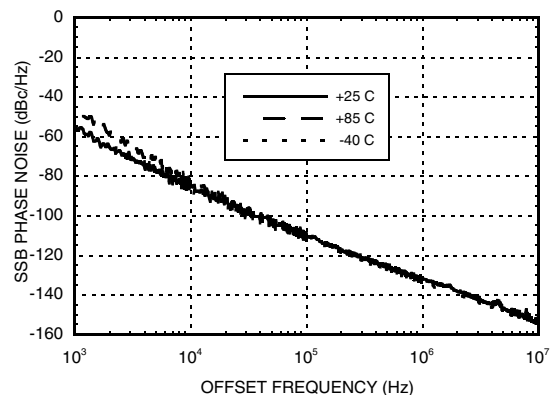
**Output Power
vs. Tuning Voltage, $V_{cc} = +3V$**



SSB Phase Noise vs. Tuning Voltage



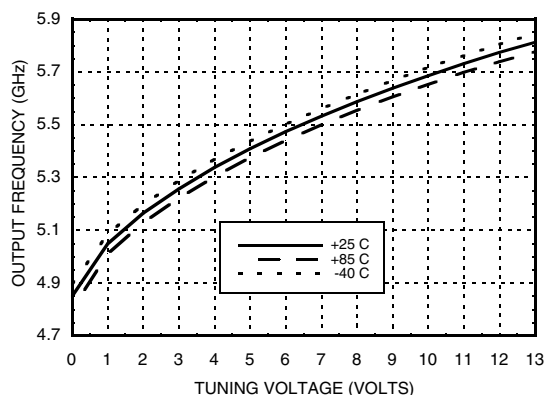
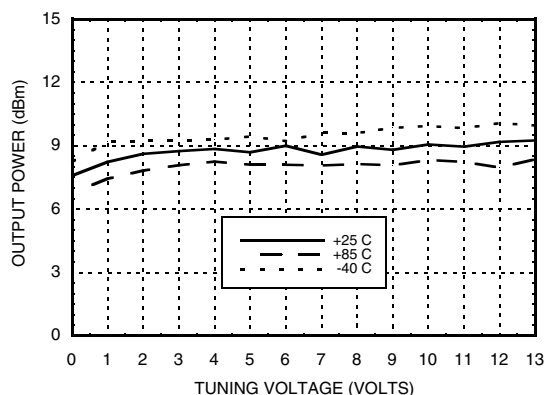
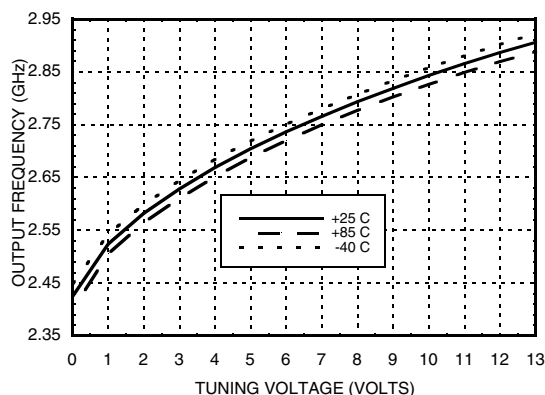
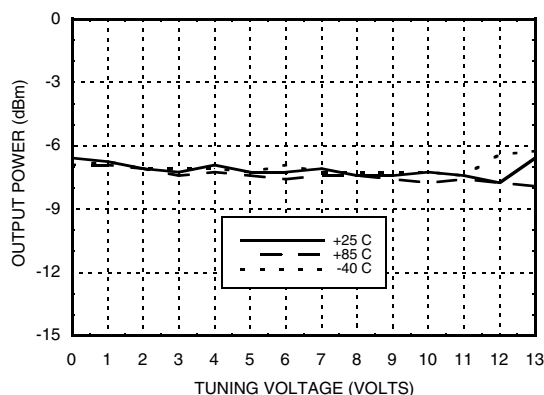
SSB Phase Noise @ $V_{tune} = +5V$





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**HMC513LP5 / 513LP5E****MMIC VCO w/ HALF FREQUENCY OUTPUT
& DIVIDE-BY-4, 10.43 - 11.46 GHz****RFOUT/2 Frequency
vs. Tuning Voltage, Vcc= +3V****RFOUT/2 Output Power
vs. Tuning Voltage, Vcc= +3V****Divide-by-4 Frequency
vs. Tuning Voltage, Vcc= +3V****Divide-by-4 Output Power
vs. Tuning Voltage, Vcc= +3V****Absolute Maximum Ratings**

Vcc1, Vcc2	+3.5 Vdc
Vtune	0 to +15V
Junction Temperature	135 °C
Continuous P _{diss} (T=85 °C) (derate 27 mW/C above 85 °C)	1.3 W
Thermal Resistance (junction to ground paddle)	37.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vcc

Vcc (V)	I _{cc} (mA)
2.75	230
3.0	275
3.25	320

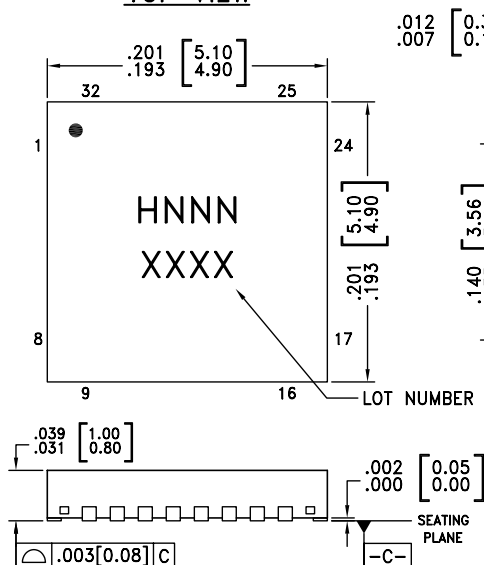
Note: VCO will operate over full voltage range shown above.

**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

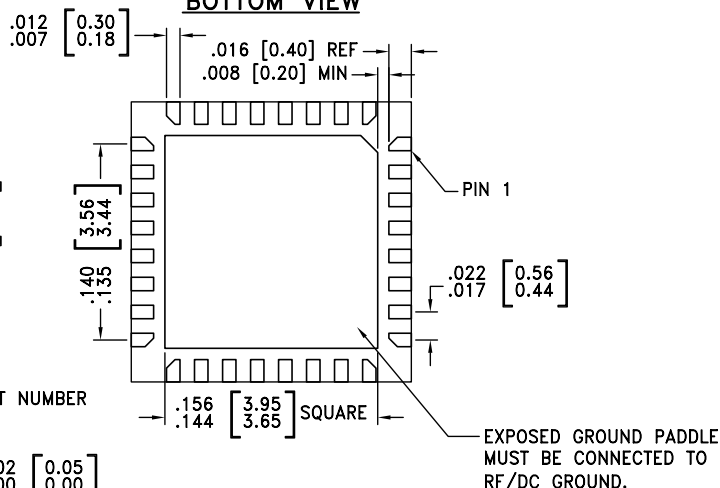


**MMIC VCO w/ HALF FREQUENCY OUTPUT
& DIVIDE-BY-4, 10.43 - 11.46 GHz**

TOP VIEW



BOTTOM VIEW



1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE
SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC513LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL3 ^[1]	H513 XXXX
HMC513LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL3 ^[2]	<u>H513</u> XXXX

[1] Max peak reflow temperature of 235 °C
[2] Max peak reflow temperature of 260 °C
[3] 4-Digit lot number XXXX

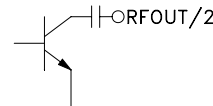
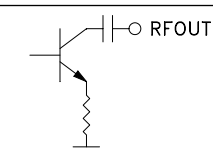
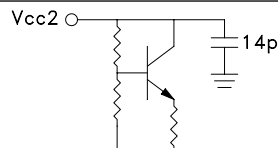
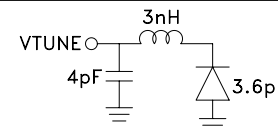

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1 - 3, 7 - 10, 13 - 18, 20, 22 - 28, 30 - 32	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
4	RFOUT/4	Divide-by-4 Output	
6	VCC1	Supply Voltage for prescaler. If prescaler is not required, this pin may be left open to conserve 40 mA of current.	

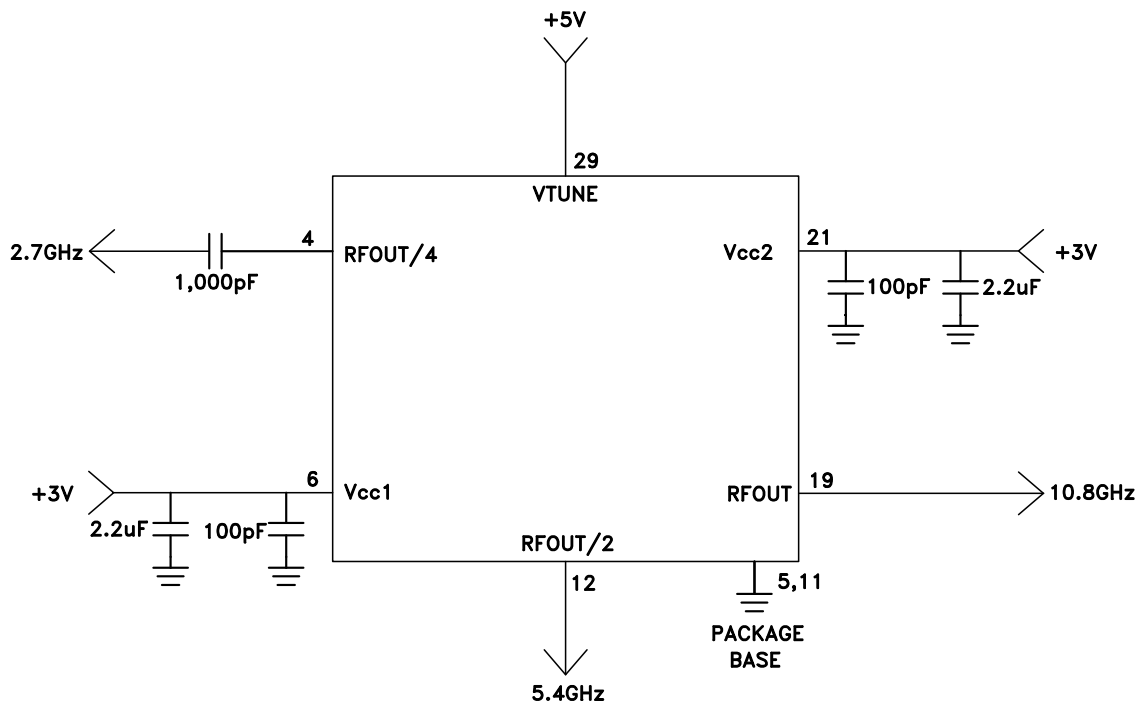


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Pin Descriptions

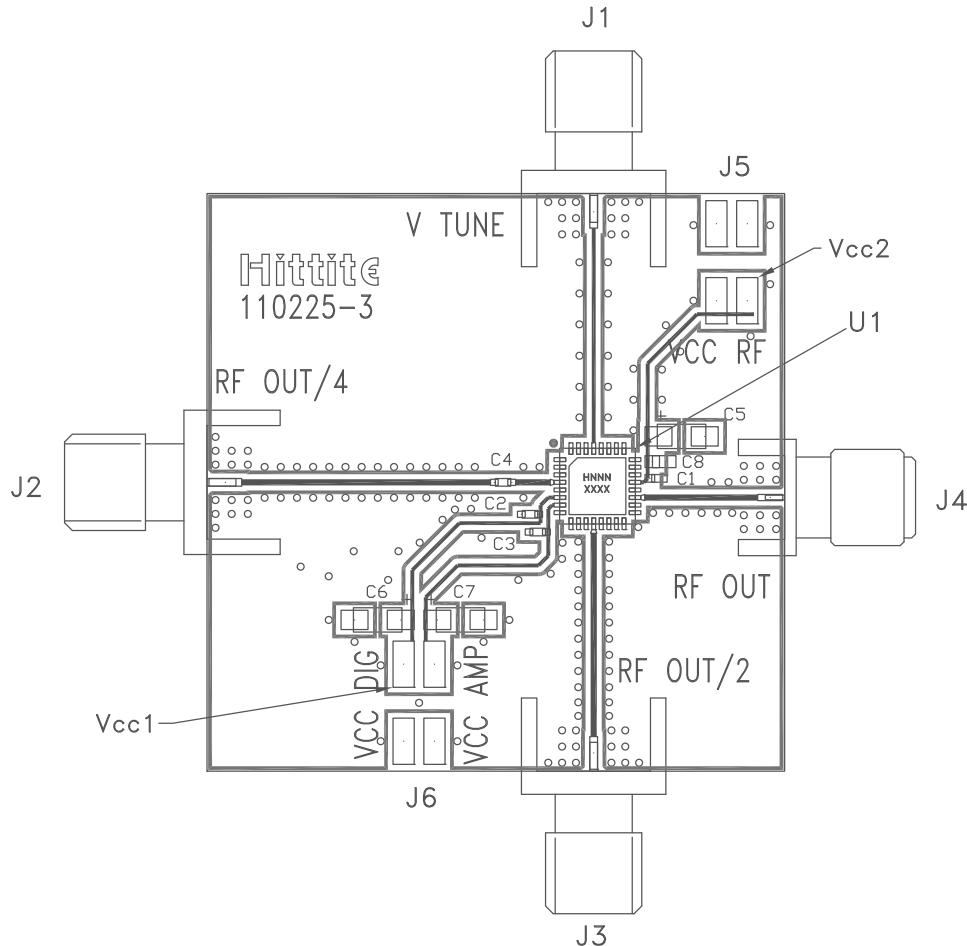
Pin Number	Function	Description	Interface Schematic
12	RFOUT/2	Half frequency output (AC coupled).	
19	RFOUT	RF output (AC coupled).	
21	VCC2	Supply Voltage, +3V	
29	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	
5, 11, Paddle	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	

Typical Application Circuit



MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 10.43 - 11.46 GHz

Evaluation PCB



List of Materials for Evaluation PCB 110227 [1]

Item	Description
J1 - J4	PCB Mount SMA RF Connector
J5 - J6	2 mm DC Header
C1 - C3	100 pF Capacitor, 0402 Pkg.
C4	1,000 pF Capacitor, 0402 Pkg.
C5 - C7	2.2 μ F Tantalum Capacitor
U1	HMC513LP5(E) VCO
PCB [2]	110225 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.